

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	I_D
-20V	94mΩ@-4.5V	-2A
	127mΩ@-2.5V	
	215mΩ@-1.8V	

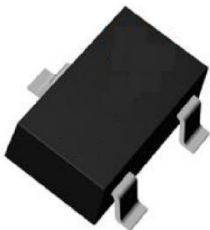
Feature

- Trench power LV MOSFET technology
- Low $R_{DS(ON)}$
- Low gate charge

Application

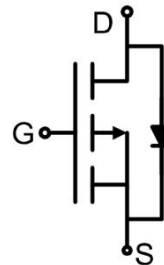
- Video monitor
- Power management

Package

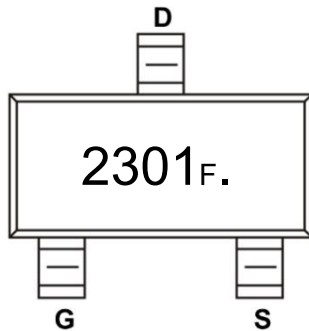


SOT-23

Circuit diagram



Marking



Absolute maximum ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-20	V
Gate-Source Voltage	V_{GS}	± 10	V
Continuous Drain Current	I_D	-2	A
Continuous Drain Current ($T_A=70^\circ\text{C}$)	$I_D(70^\circ\text{C})$	-1.6	A
Pulsed Drain Current ¹⁾	I_{DM}	-8	A
Power Dissipation	P_D	0.7	W
Thermal Resistance Junction to Ambient ²⁾	$R_{\theta JA}$	178	$^\circ\text{C}/\text{W}$
Operating Junction Temperature	T_J	-55 ~ +150	$^\circ\text{C}$
Storage Temperature	T_{STG}	-55 ~ +150	$^\circ\text{C}$

Electrical characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0\text{V}, I_D = -250\mu\text{A}$	-20			V
Zero gate voltage drain current	I_{DSS}	$V_{DS} = -20\text{V}, V_{GS} = 0\text{V}, T_C = 25^\circ\text{C}$			-1	μA
Gate-body leakage current	I_{GSS}	$V_{DS} = 0\text{V}, V_{GS} = \pm 10\text{V}$			± 100	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu\text{A}$	-0.4	-0.62	-1	V
Drain-source on-resistance	$R_{DS(on)}$	$V_{GS} = -4.5\text{V}, I_D = -1.5\text{A}$		81	94	m Ω
		$V_{GS} = -2.5\text{V}, I_D = -1.5\text{A}$		109	127	
		$V_{GS} = -1.8\text{V}, I_D = -1.5\text{A}$		183	215	
Dynamic characteristics³⁾						
Input Capacitance	C_{iss}	$V_{DS} = -10\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$		327		pF
Output Capacitance	C_{oss}			62		
Reverse Transfer Capacitance	C_{rss}			55		
Total Gate Charge	Q_g	$V_{DS} = -10\text{V}, V_{GS} = -4.5\text{V}, I_D = -2\text{A}$		4.5		nC
Gate-Source Charge	Q_{gs}			0.85		
Gate-Drain Charge	Q_{gd}			1.4		
Turn-on delay time	$t_{d(on)}$	$V_{DS} = -10\text{V}, V_{GS} = -4.5\text{V}, I_D = -1\text{A}, R_G = 2.5\Omega$		6		nS
Turn-on rise time	t_r			30		
Turn-off delay time	$t_{d(off)}$			45		
Turn-off fall time	t_f			46		
Source-Drain Diode characteristics						
Diode Forward Current	I_S				-2	A
Diode Forward voltage	V_{SD}	$V_{GS} = 0\text{V}, I_S = -2\text{A}$			-1.2	V
Reverse Recovery Time	T_{rr}	$I_F = -2\text{A}, di/dt = -100\text{A}/\mu\text{s}$		27		nS
Reverse Recovery Charge	Q_{rr}			2.3		nC

Notes:

- 1) Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
- 2) Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch.
- 3) Guaranteed by design, not subject to production testing.

Typical Characteristics

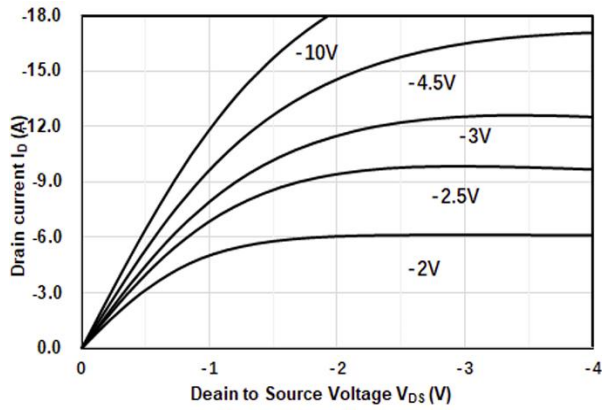


Figure1. Output Characteristics

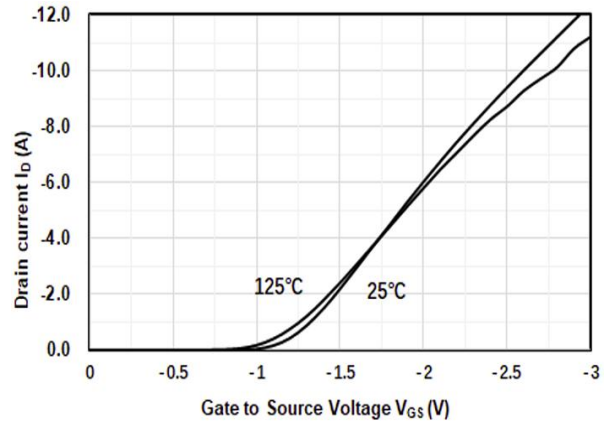


Figure2. Transfer Characteristics

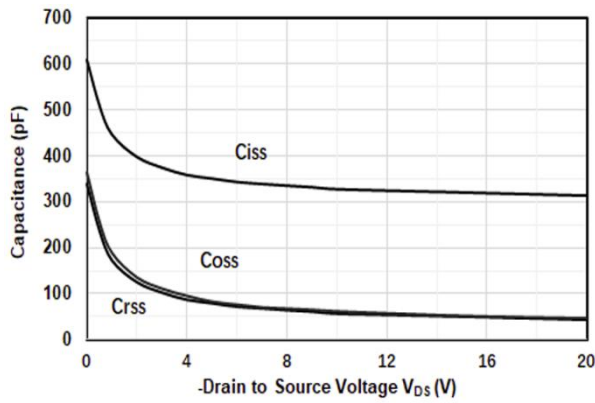


Figure3. Capacitance Characteristics

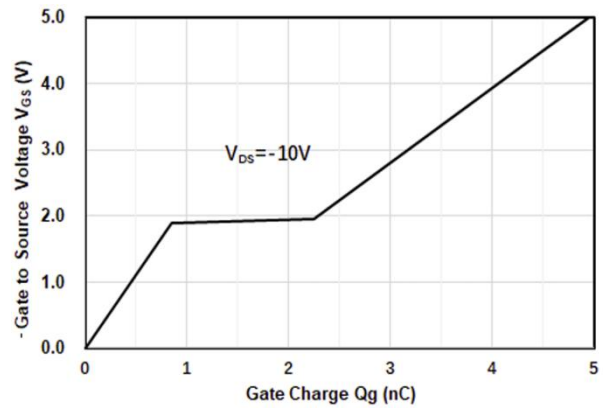


Figure4. Gate Charge

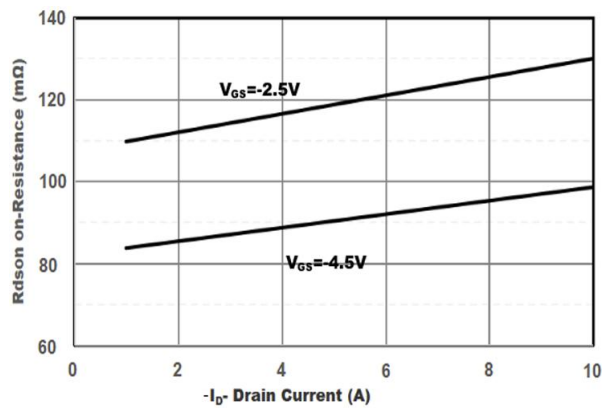


Figure5. Drain-Source on Resistance

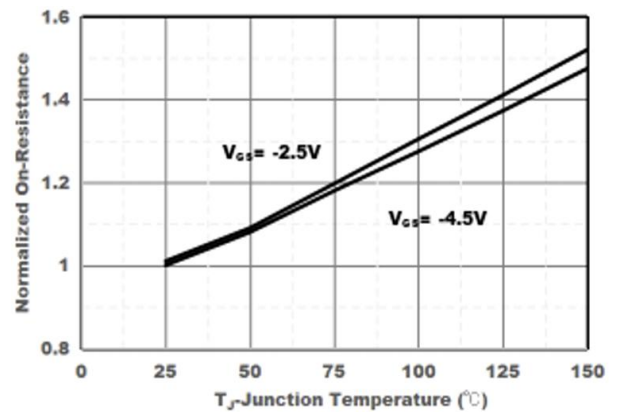


Figure6. Drain-Source on Resistance

Typical Characteristics

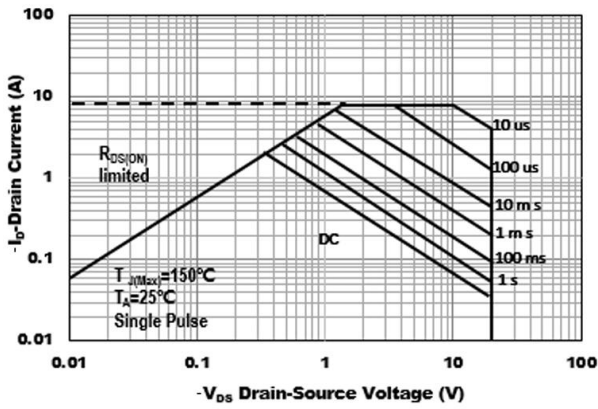


Figure7. Safe Operation Area

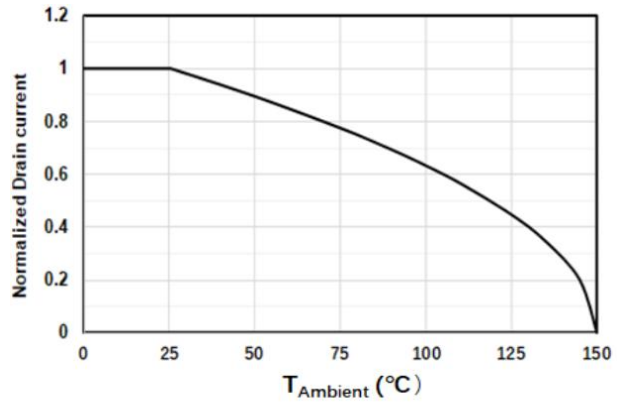


Figure8. Drain Current vs Ambient temperature

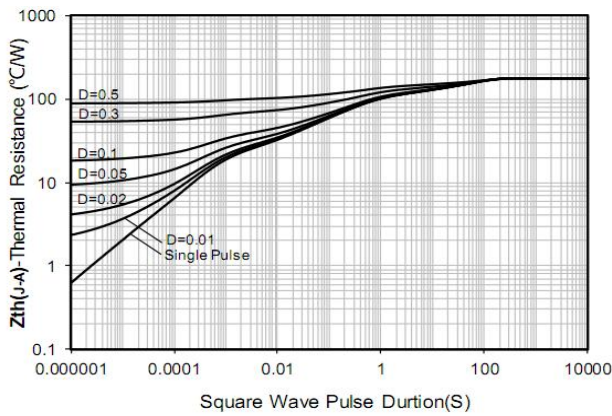
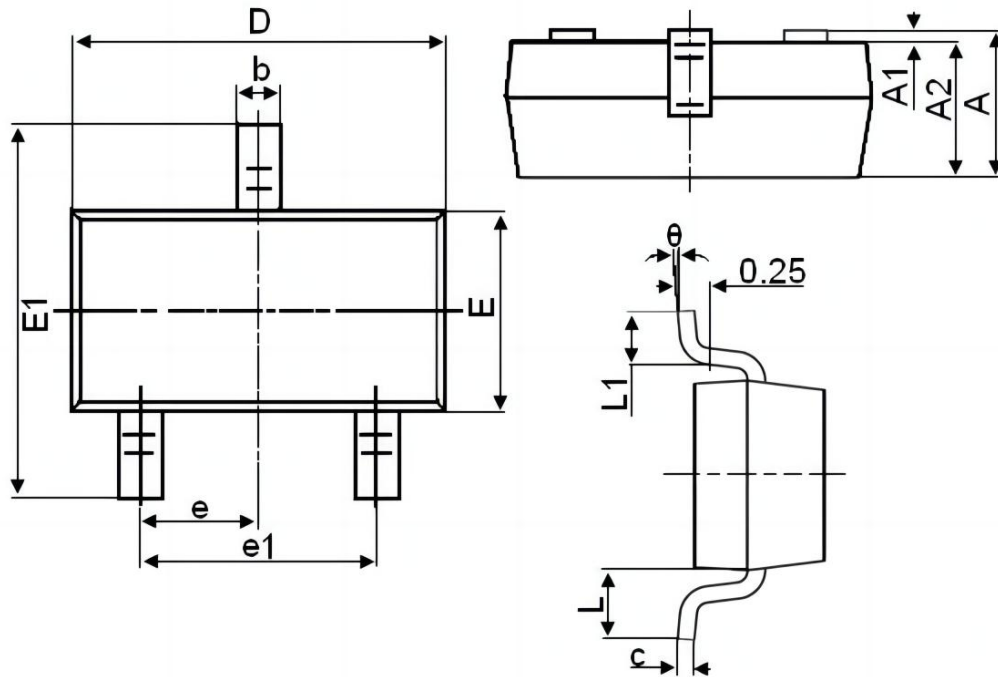


Figure9. Maximum Transient Thermal Impedance

SOT-23 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
C	0.080	0.200	0.003	0.008
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP.		0.037 TYP.	
e1	1.800	2.000	0.071	0.079
L	0.550 REF.		0.022 REF.	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°